

## Initial Product/Process Change Notification Document #: IPCN22168X Issue Date: 21 March 2018

Title of Change:	Gold wire to bare copper wire conversion for Zener and ESD Protection devices assembled in ON Semiconductor Leshan facility.			
Proposed first ship date:	30 April 2019			
Contact information:	Contact your local ON Semiconductor Sales Office or <jim.peng@onsemi.com></jim.peng@onsemi.com>			
Samples:	Samples should be available after completion of qualification. Contact your local ON Semiconductor Sales Office.			
Type of notification:	This is an Initial Product/Process Change Notification (IPCN) sent to customers. IPCNs are issued at least 30 days prior to the issuance of the Final Change Notice (FPCN). An IPCN is an advance notification about an upcoming change and contains general information regarding the change details and devices affected. It also contains the preliminary reliability qualification plan.  The completed qualification and characterization data will be included in the Final Product/Process Change Notification (FPCN). This IPCN notification will be followed by a Final Product/Process Change Notification (FPCN) at least 90 days prior to implementation of the change. In case of questions, contact <pcn.support@onsemi.com>.</pcn.support@onsemi.com>			
Change Part Identification:	Products assembled with 0.8 mils bare copper wire from ON Semiconductor Leshan facility will have a Finish Goods Date Code of May, 2019 or later.			
Change category:	☐ Wafer Fab Change ☐ Assembly Change	Test Change Other		
Change Sub-Category(s):  Manufacturing Site Change/Addition Manufacturing Process Ch	✓ Material Change ☐ Product specific change	☐ Datasheet/Product Doc change ☐ Shipping/Packaging/Marking ☐ Other:		
Sites Affected:	ON Semiconductor Sites: ON Leshan, China	External Foundry/Subcon Sites: None		
Description and Purpose:				
	Before Change Description	After Change Description		
Wire	0.8 mils gold wire	0.8 mils bare copper wire		

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## **Qualification Plan:**

Test	Specification	Condition	Interval
PC	JESD22-A113	MSL 1 @ 260 °C	Before TC, UHAST, HAST, IOL
UHAST	JESD22 A118	Ta=130C, 85% RH, no bias, 96 hrs	96 hrs
TC	JESD22-A104	Ta= - 65°C to +150°C	2000 cyc
HAST	JESD22 A110	130C/85%RH, 80% rated V or 42V max, 192 hours.	192 hrs
IOL	MIL-STD-750 (M1037)	Ta=+25°C, delta Tj=100°C, On/off = 2 min	30000 сус
HTRB	MIL-STD750-1	Tj= max, V=100% rated V, 1008 Hrs	1008 hrs
HTSL	JEDS22- A103	Temp.=150°C,no bias,2016hours	2016 hrs
RSH	JESD22- B106	Ta = 265C, 10 sec	-

Estimated date for qualification completion: 20 April 2018

## **List of Affected Standard Parts:**

Part Number	Qualification Vehicle		
ESDR0502BT1G	SZESDR0502BT1G		
MM5Z3V9T1G	SZMM5Z47VT1G		
ESD7951ST5G	SESD9L3.3ST5G		
ESD9D5.0ST5G	SESD9L3.3ST5G		

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